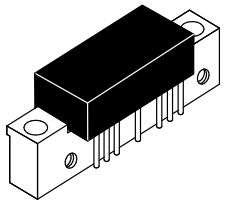
The RF Line
Wideband Linear Amplifier

CA2810C

. . . designed for amplifier applications in 50 ohm systems requiring wide bandwidth, low noise and low distortion. This hybrid provides excellent gain stability with temperature and linear amplification as a result of the push–pull circuit design.

- Specified Characteristics at V_{CC} = 24 V, T_C = 25°C:
- Frequency Range — 10 to 450 MHz
  Output Power — 1 W Typ @ 1 dB Compression, f = 200 MHz
  Power Gain — 34 dB Typ @ f = 50 MHz
  PEP — 400 mW Typ @ –32 dB IMD
  Noise Figure — 5 dB Max @ f = 300 MHz
- All Gold Metallization for Improved Reliability

34 dB
10 – 450 MHz
800 mWATT
WIDEBAND
LINEAR AMPLIFIER



CASE 714F–03, STYLE 1
[CA (POS. SUPPLY)]

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
DC Supply Voltage	V_{CC}	28	Vdc
RF Power Input	P_{in}	+5	dBm
Operating Case Temperature Range	T_C	–20 to +100	°C
Storage Temperature Range	T_{stg}	–40 to +100	°C

ELECTRICAL CHARACTERISTICS (T_C = 25°C, V_{CC} = 24 V, 50 Ω system unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
Frequency Range	BW	10	—	450	MHz
Gain Flatness (f = 10–450 MHz)	F_L	—	—	±1.5	dB
Power Gain (f = 50 MHz)	P_G	33	34	35	dB
Noise Figure, Boradband (f = 300 MHz)	NF	—	—	5	dB
Power Output — 1 dB Compression (f = 200 MHz)	$P_{o1\ dB}$	800	1000	—	mW
Third Order Intercept (See Figure 10, f_1 = 300 MHz)	ITO	—	43	—	dBm
Input/Output VSWR (f = 10–450 MHz)	VSWR	—	—	2:1	—
Second Harmonic Distortion (P_o = 100 mW, f_{2H} = 10–300 MHz)	d_{so}	—	–55	–45	dB
Reverse Isolation (f = 10–450 MHz)	—	—	40	—	dB
Peak Envelope Power (Two Tone Distortion Test — See Figure 10) (f = 10–450 MHz @ –32 dB IMD)	PEP	—	400	—	mW
Supply Current	I_{CC}	270	310	330	mA

TYPICAL CHARACTERISTICS

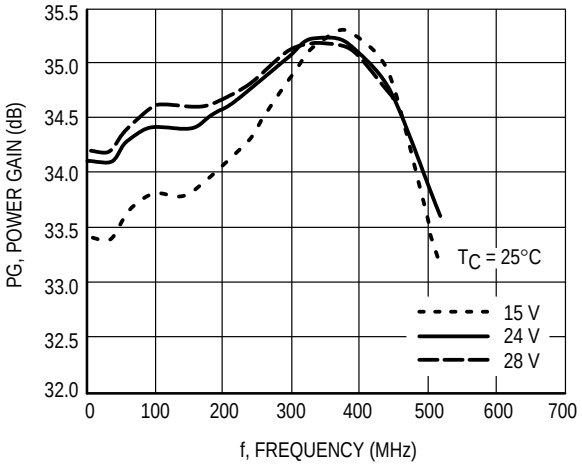


Figure 1. Power Gain versus Voltage

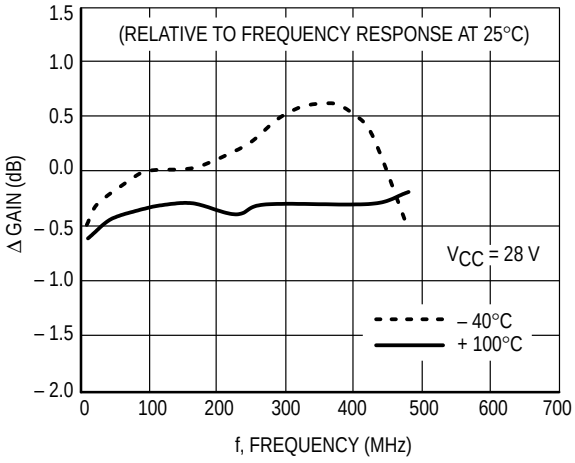


Figure 2. Relative Power Gain versus Temperature

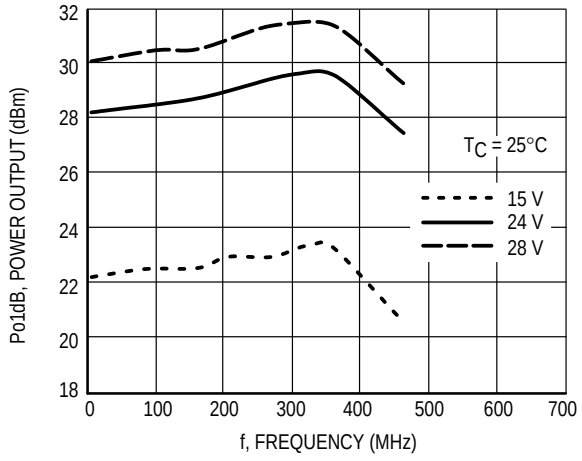


Figure 3. 1 dB Compression versus Voltage

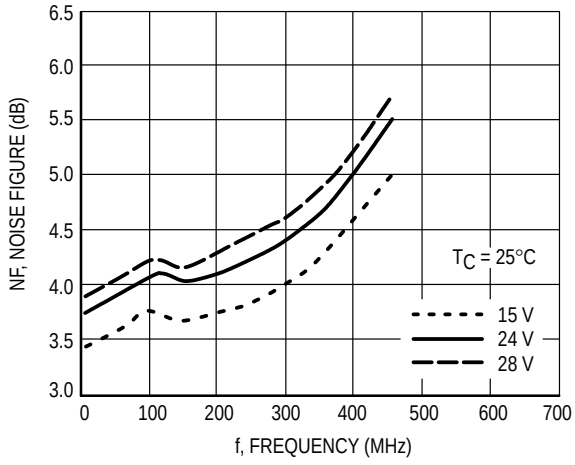


Figure 4. Noise Figure versus Voltage

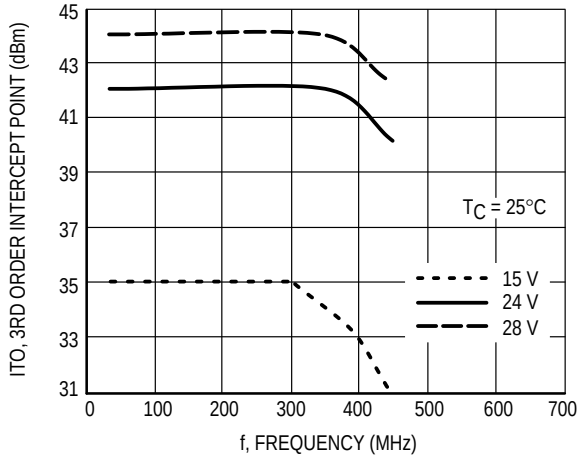


Figure 5. Third Order Intercept versus Voltage

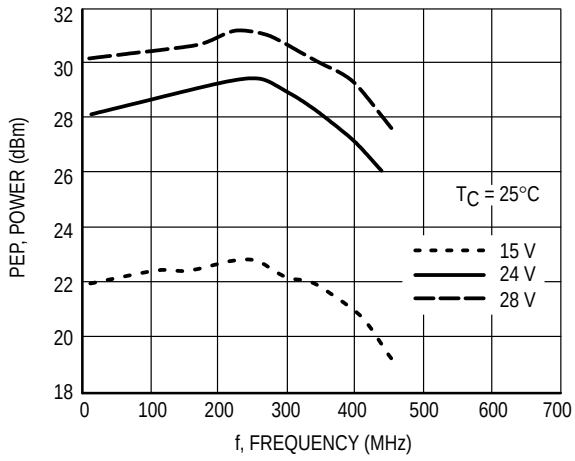


Figure 6. Peak Envelope Power versus Voltage

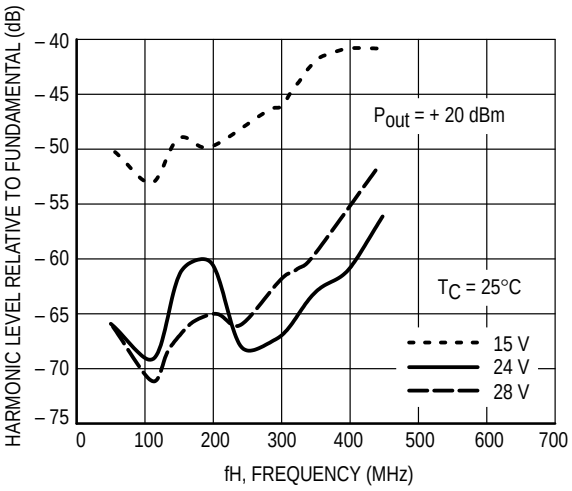


Figure 7. Second Harmonic Distortion versus Voltage

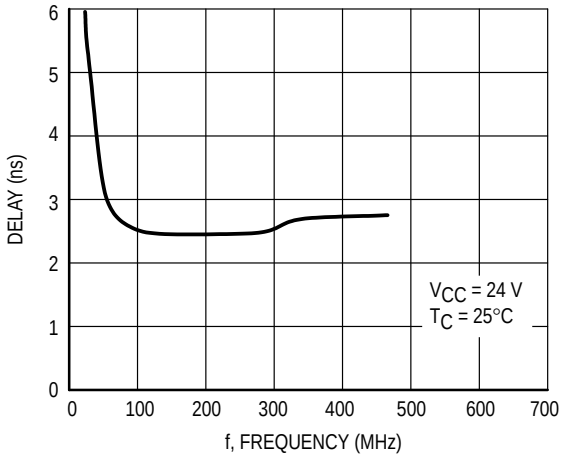


Figure 8. Group Delay versus Frequency

Biased at 24 Volts **T = 25°C Zo = 50Ω**

Frequency (MHz)	S11		S21		S12		S22	
	Mag	Ang	Mag	Ang	Mag	Ang	Mag	Ang
10	–13.8	3.5	34.2	–145	–46	–131	–13.5	8.2
50	–16.0	–3.0	34.2	150	–47	–172	–18.5	4.6
100	–14.4	–14	34.4	88	–48	102	–14.5	–9.2
200	–13.2	–50	34.6	2	–42	35	–13.2	–80
300	–13.9	–79	35.0	–80	–46	65	–16.7	–49
400	–14.1	–115	35.0	–80	–48	–44	–14.2	11
450	–16.2	–122	34.6	120	–53	–82	–13.8	–46

Magnitude in dB, Phase Angle in degrees.

Table 1. S–Parameters

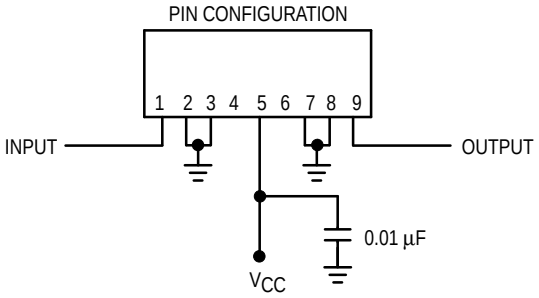
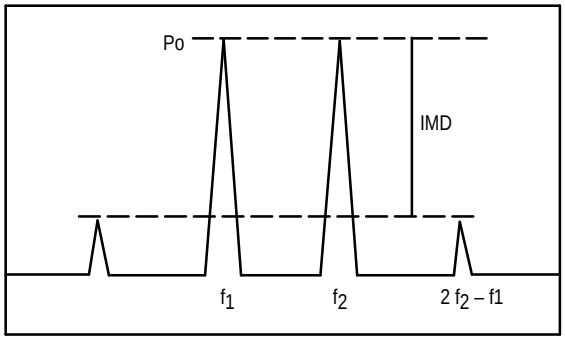


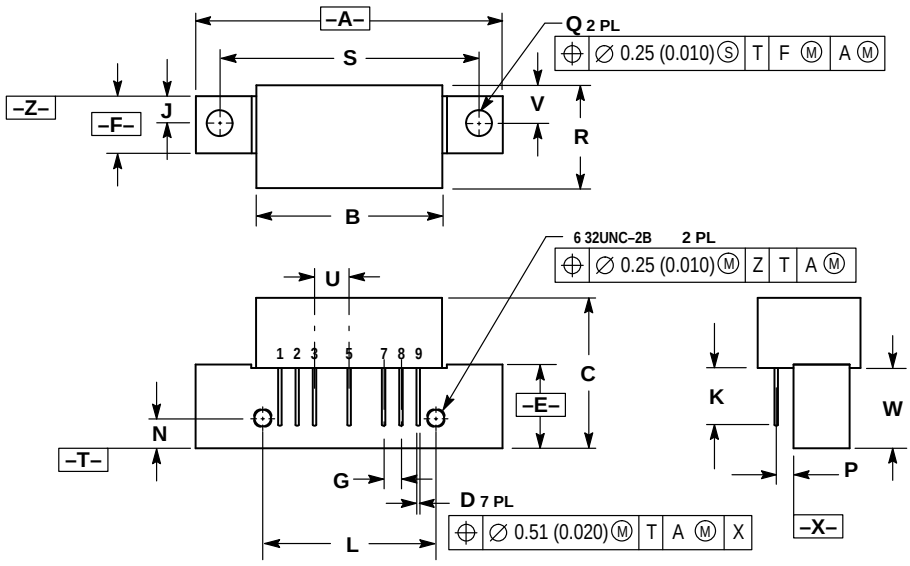
Figure 9. External Connections



ITO = Po + IMD / 2 @ IMD > 60 dB
PEP = 4 x Po @ IMD = – 32 dB

Figure 10. Intermodulation Test

PACKAGE DIMENSIONS



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	——	1.775	——	45.08
B	——	1.085	——	27.56
C	——	0.870	——	22.10
D	0.018	0.022	0.46	0.56
E	0.465	0.510	11.81	12.95
F	0.300	0.325	7.62	8.25
G	0.100 BSC		2.54 BSC	
J	0.156 BSC		3.96 BSC	
K	0.330	0.370	8.38	9.40
L	1.000 BSC		25.40 BSC	
N	0.165 BSC		4.19 BSC	
P	0.100 BSC		2.54 BSC	
Q	0.148	0.168	3.76	4.27
R	——	0.595	——	15.11
S	1.500 BSC		38.10 BSC	
U	0.200 BSC		5.08 BSC	
V	0.209	0.239	5.31	6.07
W	0.425	——	10.80	——

STYLE 1:
PIN 1. RF INPUT
2. GROUND
3. GROUND
5. $+V_{CC}$
7. GROUND
8. GROUND
9. RF OUTPUT

CASE 714F–03
ISSUE C

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